

COMLINEAR® CLC1002 Ultra-Low Noise Amplifier

FEATURES

- 0.6 nV/√Hz input voltage noise
- 1mV maximum input offset voltage
- 965MHz gain bandwidth product
- Minimum stable gain of 5
- 170V/µs slew rate
- 130mA output current
- -40°C to +125°C operating temperature range
- Fully specified at 5V and ±5V supplie
- CLC1002: Lead-free SOT23-6

APPLICATIONS

- Transimpedance amplifiers
- Pre-amplifier
- Low noise signal processing
- Medical instrumentation
- Probe equipment
- Test equipment
- Ultrasound channel amplifier

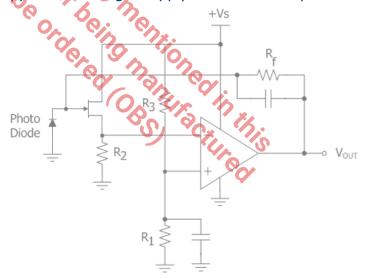
General Description

The COMLINEAR CLC1002(single) is a high-performance, voltage feed-back amplifier with ultra-low input voltage noise, $0.6nV/\sqrt{Hz}$. The CLC1002 provides 965MHz gain bandwidth product and $170V/\mu s$ slew rate making it well suited for high-speed data acquisition systems requiring high levels of sensitivity and signal integrity. This COMLINEAR high-performance amplifier also offers low input offset voltage.

The COMLINEAR CLC1002 is designed to operate from 4V to 12V supplies. It consumes only 13mA of supply current per channel and offers a power saving disable pin that disables the amplifier and decreases the supply current to below 225 μ A. The CLC1002 amplifier operates over the extended temperature range of -40°C to +125°C.

If larger bandwidth or slew rate is required, a higher minimum stable gain version is available, the CLC1001 offers a minimum stable gain of 10 with 2.1GHz GBWP and 410V/µs slew rate.

Typical Application - Single Supply Photodiode Amplifier

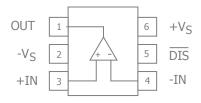


Ordering Information

Part Number	Package	Pb-Free	RoHS Compliant	Operating Temperature Range	Packaging Method
CLC1002IST6X	SOT23-6	Yes	Yes	-40°C to +125°C	Reel
CLC1002ISO8X	SOIC-8	Yes	Yes	-40°C to +125°C	Reel
CLC1002ISO8	SOIC-8	Yes	Yes	-40°C to +125°C	Rail

Moisture sensitivity level for all parts is MSL-1.

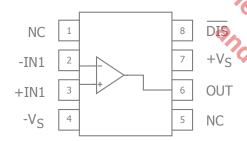
CLC1002 Pin Configuration



CLC1002 Pin Assignments

Pin No.	Pin Name	Description
1	OUT	Output
2	-V _S	Negative supply
3	+IN	Positive input
4	-IN	Negative input
5	DIS	Disable. Enabled if pin is left floating or pulled above V _{ON} , disabled if pin is grounded or pulled below V _{OFF} .
6	+V _S	Positive supply

SOIC Pin Configuration



on Q	The	SOIC Din /	Assignments	
711	SON TO SON	in No.	Pin Name	Description
_	100	D.	NC	No connect
8	DIS	2	-IN1	Negative input
		3 0	+IN1	Positive input
7	+V _S	4)	-V _S	Negative supply
6	OUT	5	NC	No connect
5	1 NC	6	0010	Output
5	NC	7 *	YV _S	Positive supply
		8	O, DIS O	Osable. Enabled if pin is left floating or pulled above V _{ON} , disabled if pin is grounded or pulled below V _{OFF} .
			Con (above V _{ON} , disabled if pin is grounded or pulled below V _{OFF} .

Absolute Maximum Ratings

The safety of the device is not guaranteed when it is operated above the "Absolute Maximum Ratings". The device should not be operated at these "absolute" limits. Adhere to the "Recommended Operating Conditions" for proper device function. The information contained in the Electrical Characteristics tables and Typical Performance plots reflect the operating conditions noted on the tables and plots.

Parameter	Min	Max	Unit
Supply Voltage	0	14	V
Input Voltage Range	-V _s -0.5V	+V _s +0.5V	V

Reliability Information

Parameter	Min	Тур	Max	Unit
Junction Temperature			150	°C
Storage Temperature Range	-65		150	°C
Lead Temperature (Soldering, 10s)			260	°C
Package Thermal Resistance				
6-Lead SOT23		177		°C/W
8-Lead SOIC		100		°C/W

Notes:

Notes: Package thermal resistance (θ_{JA}) , JDEC standard, multi-layer test boards, still air

ESD Protection

Product	SOT23-6
Human Body Model (HBM)	260
Charged Device Model (CDM)	2k∀ /2

Recommended Operating Conditions

Parameter	Min	Max Max	Unit
Operating Temperature Range (CLC1002I)	-40	+ 85	°C
Operating Temperature Range (CLC1002A)	-40	+125	°C
Supply Voltage Range	4	12	V

Electrical Characteristics at +5V

 $T_A=25$ °C, $V_S=+5V$, $-V_S=GND$, $R_f=100\Omega$, $R_L=500\Omega$ to $V_S/2$, G=5; unless otherwise noted.

$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Symbol	Parameter	Conditions	Min	Тур	Max	Units
BMV _S -3dB Bandwidth G = +5, V _{OUT} = 2V _{pp} 54 MHz	Frequency D	omain Response					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	GBWP	-3dB Gain Bandwidth Product	$G = +21$, $V_{OUT} = 0.2V_{pp}$		910		MHz
BW _{0,1688} 0.14B Cain Flatness Small Signal G = +5, V _{OUT} = 0.2V _{op} 0.29 MHz	BW _{SS}	-3dB Bandwidth			265		MHz
BW _{0,1688} 0.14B Cain Flatness Small Signal G = +5, V _{OUT} = 0.2V _{op} 0.29 MHz	BW _{LS}	Large Signal Bandwidth	$G = +5$, $V_{OUT} = 2V_{DD}$		54		MHz
BM _{0,140116} D.1.dB Cain Fishness Large Signal G = +5, V _{0,107} = 2V _{top} Depth De	BW _{0.1dBSS}	0.1dB Gain Flatness Small Signal			37		MHz
Time Domain Response	BW _{0.1dBLS}	0.1dB Gain Flatness Large Signal			29		MHz
ts Settling Time to 0.1%		n Response					
ts Settling Time to 0.1%	t _R , t _F	Rise and Fall Time	V _{OUT} = 1V step; (10% to 90%)		4.2		ns
Sign Siew Rate		Settling Time to 0.1%			12		ns
Distortion/Noise Response	OS	Overshoot	V _{OUT} = 1V step		3		%
HD2	SR	Slew Rate			160		V/µs
HD3	Distortion/No	oise Response					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	HD2	2nd Harmonic Distortion	1V _{pp} , 10MHz		-72		dBc
This Total Harmonic Distortion 1	HD3	3rd Harmonic Distortion			-74		dBc
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	THD	Total Harmonic Distortion			-70		dB
Input Current Noise	e _n	Input Voltage Noise			0.6		nV/√Hz
V _{IO} Input Offset Voltage 0.1 mV					4.2		pA/√Hz
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			D. D.				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			70 0		0.1		mV
In Decided (In part Bias Current) 28 μA dID Ad (ID		-	16 4/1		2.7		µV/°C
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			no no Cx		28		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		<u>'</u>	0, 00		46		nA/°C
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			00 6 2		0.1		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		<u>'</u>	DC O		83		-
Supply Current per channel 12.5 mA		117 3					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$					12.5		mA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			0/ 12 16				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			1V step, 1% settling		80		ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		Turn Off Time	000	7	220		ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		Off Isolation	2V _{ppr} 5MHz	On V	73		dB
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		Off Output Capacitance	PP'	4			pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			Disabled if DIS pin is grounded or pulled below Vorr	Disc		< 1.5	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		-					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		1	, , ,				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		1	Non-inverting		4.2		ΜΩ
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		· ·	3		2		pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$					0.8 to		
$V_{OUT} \begin{array}{c} \text{Output Characteristics} \\ \\ V_{OUT} \end{array} \begin{array}{c} R_L = 500\Omega \\ \\ R_L = 2k\Omega \end{array} \begin{array}{c} 0.97 \text{ to} \\ 4 \\ \\ R_L = 2k\Omega \end{array} \begin{array}{c} 0.96 \text{ to} \\ 4.1 \\ \\ V \end{array}$	CMRR	Common Mode Rejection Ratio	DC . V ₂₀₀ =1.5V to 4V				dB
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		-	, un				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-		$R_L = 500\Omega$				V
I _{OUT} Output Current ±125 mA	V _{OUT}	Output Voltage Swing	$R_L = 2k\Omega$		0.96 to		V
001	I _{OUT}	Output Current					mA
		<u> </u>	$V_{OUT} = V_S / 2$				

Notes:

1. 100% tested at 25°C

Electrical Characteristics at ±5V

 $T_A=25^{\circ}\text{C},\,V_S=\pm5\text{V},\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Frequency D	omain Response					
GBWP	-3dB Gain Bandwidth Product	$G = +21, V_{OUT} = 0.2V_{pp}$		965		MHz
BW _{SS}	-3dB Bandwidth	$G = +5$, $V_{OUT} = 0.2V_{pp}$		290		MHz
BW _{LS}	Large Signal Bandwidth	$G = +5$, $V_{OUT} = 2V_{pp}$		61		MHz
BW _{0.1dBSS}	0.1dB Gain Flatness Small Signal	$G = +5$, $V_{OUT} = 0.2V_{pp}$		45		MHz
BW _{0.1dBLS}	0.1dB Gain Flatness Large Signal	$G = +5$, $V_{OUT} = 2V_{pp}$		32		MHz
Time Domair		рр				
t _R , t _F	Rise and Fall Time	V _{OUT} = 1V step; (10% to 90%)		3.8		ns
t _S	Settling Time to 0.1%	V _{OUT} = 1V step		12		ns
OS	Overshoot	V _{OUT} = 1V step		2		%
SR	Slew Rate	2V step		170		V/µs
Distortion/No	oise Response					
HD2	2nd Harmonic Distortion	2V _{pp} , 10MHz		-75		dBc
HD3	3rd Harmonic Distortion	2V _{pp} , 10MHz		-66		dBc
THD	Total Harmonic Distortion	2V _{pp} , 5MHz		-65.5		dB
e _n	Input Voltage Noise	> 100kHz		0.6		nV/√Hz
i _n	Input Current Noise	> 100kHz		4.2		pA/√Hz
DC Performa	ance	D.				
V _{IO}	Input Offset Voltage(1)	70 0-	-1	0.5	1	mV
dV _{IO}	Average Drift	6 4/4		4.3		μV/°C
I _b	Input Bias Current (1)	70 72 Cx	-60	30	60	μА
dI _b	Average Drift	0, 00, 0		44		nA/°C
I _o	Input Offset Current	0 4 2		0.3	6	μA
PSRR	Power Supply Rejection Ratio (1)	DC O	78	83		dB
A _{OL}	Open-Loop Gain (1)	$V_{OUT} = V_S/2$	70	83		dB
I _S	Supply Current (1)	per channel		13	16	mA
Disable Char	1	0/ 72 10				
t _{ON}	Turn On Time	1V step, 1% settling	9	115		ns
t _{OFF}	Turn Off Time		· 17	210		ns
OFF _{ISO}	Off Isolation	2V _{pp} , 5MHz	Ox 9	73		dB
OFFC _{OUT}	Off Output Capacitance	pp·	C/A	5.7		pF
V _{OFF}	Power Down Voltage	Disabled if DIS pin is grounded or pulled below V _{OFF}	Dis	bled if DIS	< 1 3	V
V _{ON}	Enable Voltage	Enabled if DIS pin is floating or pulled above V_{ON}	-	abled if DIS		V
I _{SD}	Disable Supply Current (1)	No Load, DIS pin tied to ground		180	225	μA
Input Charac	1					
R _{IN}	Input Resistance	Non-inverting		9.4		ΜΩ
C _{IN}	Input Capacitance			1.82		pF
CMIR	Common Mode Input Range			-4.3 to 5		V
CMRR	Common Mode Rejection Ratio (1)	DC , V _{cm} =-3.5V to 4V	75	90		dB
Output Char	-	- / · · · · · · · · · · · · · · · · · ·		30		
3 3 5 5 5 6 7 6 7 6 7 6 7 6 7 6 7 6 7 6 7 6		$R_{I} = 500\Omega^{(1)}$	-3.3	±4	3.6	V
V _{OUT}	Output Voltage Swing	$R_L = 2k\Omega$	5.5	±4	5.0	V
I _{OUT}	Output Current			±130		mA
I _{SC}	Short-Circuit Output Current	$V_{OUT} = V_S / 2$		±165		mA
*SC	S.I.S. Con cont Output Current	-UUI *5/ -		-105		111/1

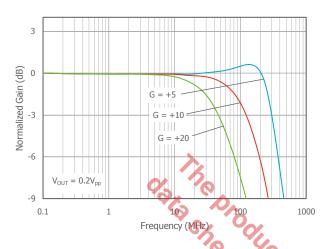
Notes:

1. 100% tested at 25°C

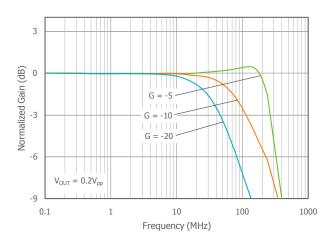
Typical Performance Characteristics

 $T_A = 25$ °C, $V_S = \pm 5$ V, $R_f = 100\Omega$, $R_L = 500\Omega$, G = 5; unless otherwise noted.

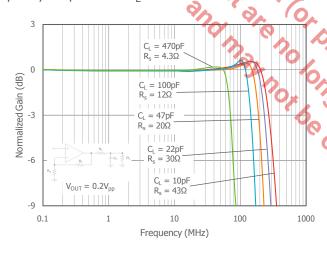
Non-Inverting Frequency Response



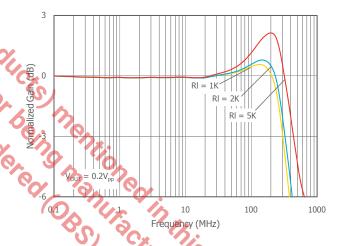
Inverting Frequency Response



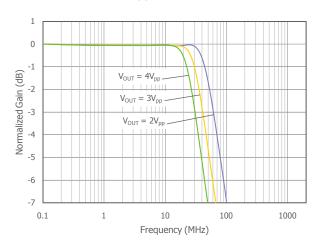
Frequency Response vs. C_I



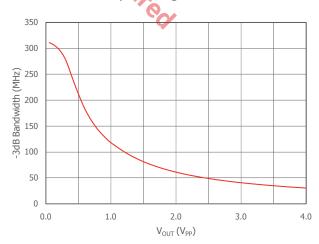
Frequency Response vs. R_I



Frequency Response vs. V_{OUT}



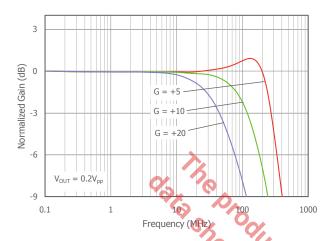
-3dB Bandwidth vs. Output Voltage



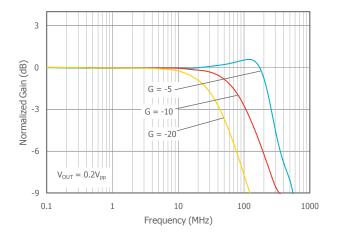
Typical Performance Characteristics

 $T_A = 25$ °C, $V_S = \pm 5$ V, $R_f = 100\Omega$, $R_L = 500\Omega$, G = 5; unless otherwise noted.

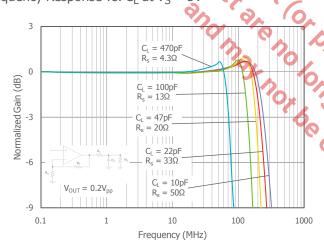
Non-Inverting Frequency Response at $V_S = 5V$



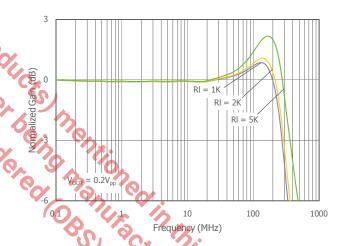
Inverting Frequency Response at $V_S = 5V$



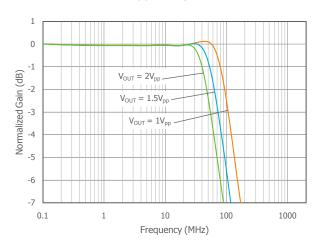
Frequency Response vs. C_L at $V_S = 5V$



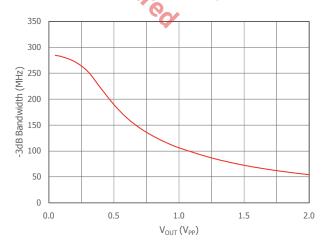
Frequency Response vs. R_I at $V_S = 5V$



Frequency Response vs. V_{OUT} at $V_S = 5V$

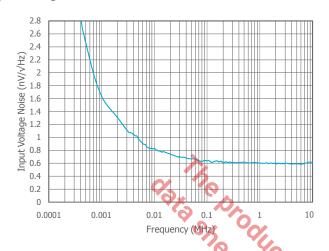


-3dB Bandwidth vs. Output Voltage at $V_S = 5V$

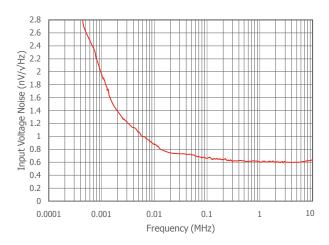


 $T_A = 25$ °C, $V_S = \pm 5$ V, $R_f = 100\Omega$, $R_L = 500\Omega$, G = 5; unless otherwise noted.

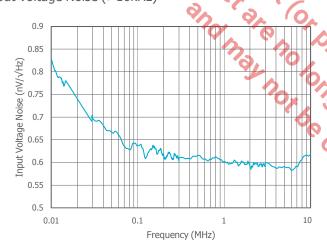
Input Voltage Noise



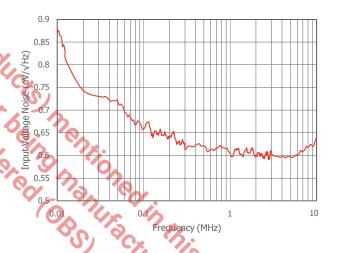
Input Voltage Noise at $V_S = 5V$



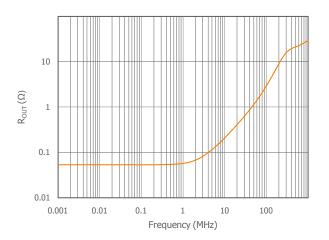
Input Voltage Noise (>10kHz)



Input Voltage Noise at $V_S = 5V$ (>10kHz)



R_{OUT} vs. Frequency

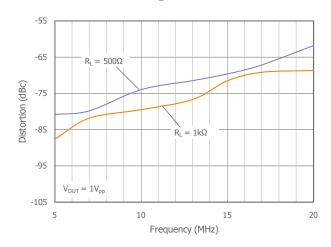


 $T_A=25^{\circ}\text{C},\,V_S=\pm5\text{V},\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

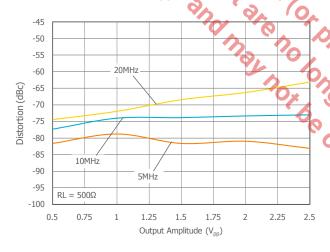
2nd Harmonic Distortion vs. R_L



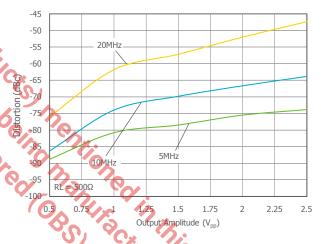
3rd Harmonic Distortion vs. R_L



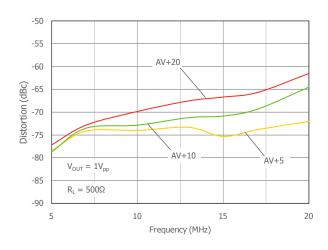




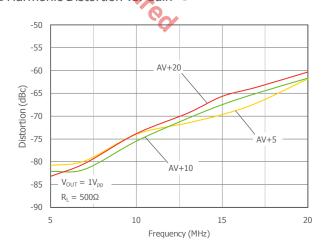
3rd Harmonic Distortion vs. V_{OUT}



2nd Harmonic Distortion vs. Gain

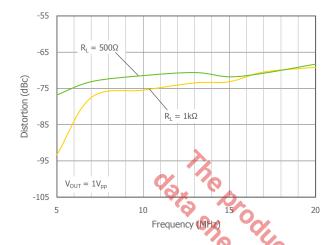


3rd Harmonic Distortion Vs. Gain

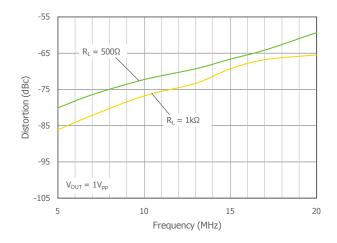


 $T_A=25^{\circ}\text{C},\,V_S=\pm5\text{V},\,R_f=100\Omega,\,R_L=500\Omega$, G=5; unless otherwise noted.

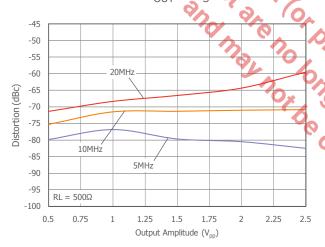
2nd Harmonic Distortion vs. R_L at $V_S = 5V$



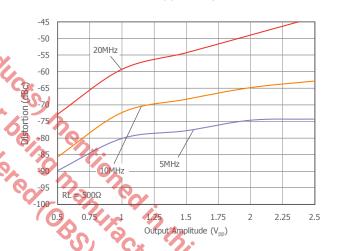
3rd Harmonic Distortion vs. R_L at $V_S = 5V$



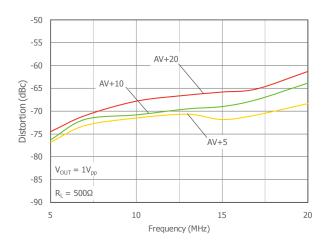
2nd Harmonic Distortion vs. V_{OUT} at $V_S = SV$



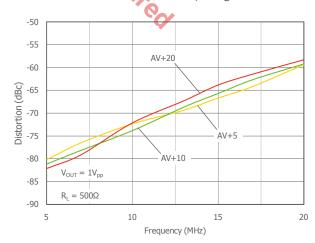
3rd Harmonic Distortion vs. V_{OUT} at $V_S = 5V$



2nd Harmonic Distortion vs. Gain at $V_S = 5V$

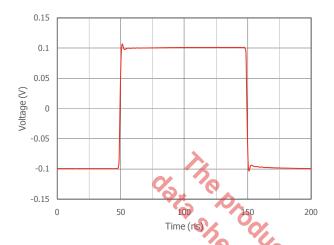


3rd Harmonic Distortion vs. Gain Freq at $V_S = 5V$

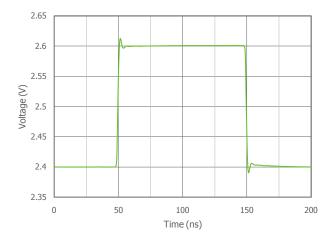


 $T_A = 25$ °C, $V_S = \pm 5$ V, $R_f = 100\Omega$, $R_L = 500\Omega$, G = 5; unless otherwise noted.

Small Signal Pulse Response



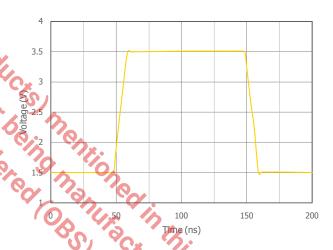
Small Signal Pulse Response at $V_S = 5V$



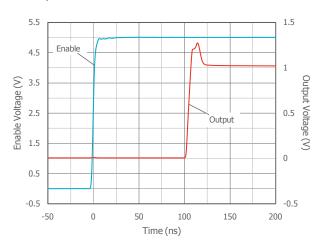
Large Signal Pulse Response



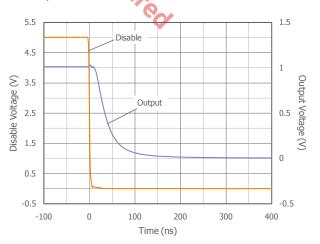
Large Signal Pulse Response at $V_S = 5V$



Enable Response

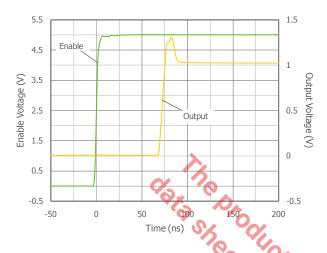


Disable Response

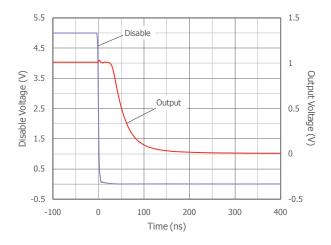


 $T_A = 25$ °C, $V_S = \pm 5$ V, $R_f = 100\Omega$, $R_L = 500\Omega$, G = 5; unless otherwise noted.

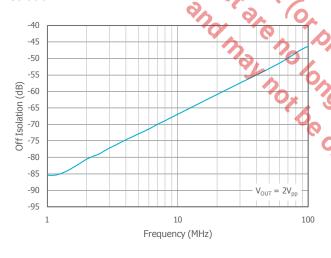
Enable Response at $V_S = 5V$



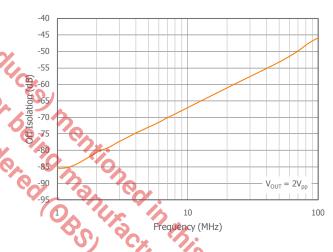
Disable Response at $V_S = 5V$



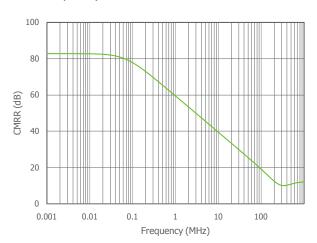
Off Isolation



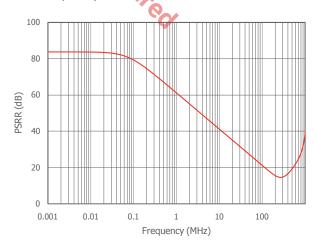
Off Isolation at $V_S = 5V$



CMRR vs. Frequency



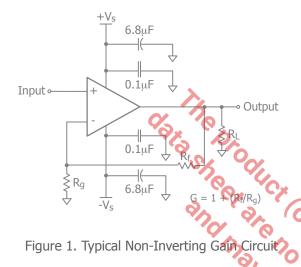
PSRR vs. Frequency



Application Information

Basic Operation

Figures 1 and 2 illustrate typical circuit configurations for non-inverting, inverting, and unity gain topologies for dual supply applications. They show the recommended bypass capacitor values and overall closed loop gain equations.



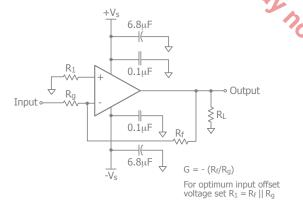


Figure 2. Typical Inverting Gain Circuit

Achieving Low Noise in an Application

Making full use of the low noise of the CLC1002 requires careful consideration of resistor values. The feedback and gain set resistors (Rf and Rq) and the non-inverting source impedance (R_{source}) all contribute noise to the circuit and can easily dominate the overall noise if their values are too high. The datasheet is specified with an R_q of 25Ω , at which point the noise from $R_{\mbox{\scriptsize f}}$ and $R_{\mbox{\scriptsize g}}$ is about equal to the noise from the CLC1002. Lower value resistors could be used at the expense of more distortion.

Figure 3 shows total input voltage noise (amp+resistors) versus R_f and R_q . As the value of R_f increases, the total input referred noise also increases.

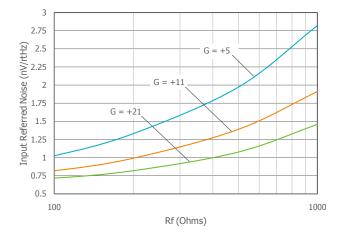


Figure 3: Input Referred Voltage Noise vs. Rf and Rq

The noise caused by a resistor is modeled with either a voltage source in series with the resistance:

Or a current source in parallel with it: $i_R = \sqrt{\frac{4kT}{R}}$

$$_{R} = \sqrt{\frac{4kT}{R}}$$

Op amp noise is modeled with three noise sources, e_{n} , i_{n} and ii. These three sources are analogous to the DC input voltage and current errors Vos Ibn and Ibi.

The noise models must be analyzed in-circuit to determine the effect on the op amp output noise.

Since noise is statistical in nature rather than a continuous signal, the set of noise sources in circuit add in an RMS (root mean square) fashion rather than in a linear fashion. For uncorrelated noise sources, this means you add the squares of the noise voltages. A typical non-inverting application (see figure 1) results in the following noise at the output of the op amp:

$$e_o^2 = e_n^2 \left(1 + \frac{R_f}{R_g} \right)^2 + in^2 R_s^2 \left(1 + \frac{R_f}{R_g} \right)^2 + i_i^2 R_f^2$$

op amp noise terms e_n, i_n and i_i

$$+ e_{Rs}^2 \left(1 + \frac{R_f}{R_g} \right)^2 + e_{Rg}^2 \left(\frac{R_f}{R_g} \right)^2 + e_{Rf}^2$$

external resistor noise terms for R_S, R_a and R_f

High source impedances are sometimes unavoidable, but they increase noise from the source impedance and also make the circuit more sensitive to the op amp current noise. Analyze all noise sources in the circuit, not just the op amp itself, to achieve low noise in your application.

Power Dissipation

Power dissipation should not be a factor when operating under the stated 500Ω load condition. However, applications with low impedance, DC coupled loads should be analyzed to ensure that maximum allowed junction temperature is not exceeded. Guidelines listed below can be used to verify that the particular application. will not cause the device to operate beyond it's intended operating range.

Maximum power levels are set by the absolute maximum junction rating of 150°C. To calculate the junction temperature, the package thermal resistance value Theta_{1A} (Θ_{1A}) is used along with the total die power dissipation.

$$T_{Junction} = T_{Ambient} + (\Theta_{JA} \times P_{D})$$

Where T_{Ambient} is the temperature of the working environment.

In order to determine P_D, the power dissipated in the load needs to be subtracted from the total power delivered by the supplies.

$$P_D = P_{supply} - P_{load}$$

Supply power is calculated by the standard power equation.

$$P_{\text{supply}} = V_{\text{supply}} \times I_{\text{RMS supply}}$$

 $V_{\text{supply}} = V_{\text{S+}} - V_{\text{S-}}$

Power delivered to a purely resistive load is:

$$P_{load} = ((V_{LOAD})_{RMS^2})/Rload_{eff}$$

The effective load resistor (Rloadeff) will need to include the effect of the feedback network. For instance, Rloadeff ©2007-2013 Exar Corporation

in figure 3 would be calculated as:

$$R_L \mid\mid (R_f + R_q)$$

These measurements are basic and are relatively easy to perform with standard lab equipment. For design purposes however, prior knowledge of actual signal levels and load impedance is needed to determine the dissipated power. Here, PD can be found from

$$P_D = P_{Quiescent} + P_{Dynamic} - P_{Load}$$

Quiescent power can be derived from the specified IS values along with known supply voltage, V_{Supply}. Load power can be calculated as above with the desired signal amplitudes using:

$$(V_{LOAD})_{RMS} = V_{PEAK} / \sqrt{2}$$

 $(I_{I,OAD})_{RMS} = (V_{I,OAD})_{RMS} / Rload_{eff}$

The dynamic power is focused primarily within the output stage driving the load. This value can be calculated as:

$$P_{DYNAMIC} = (V_{S+} - V_{LOAD})_{RMS} \times (I_{LOAD})_{RMS}$$

Assuming the load is referenced in the middle of the power rails or $V_{\text{supply}}/2$.

Figure 4 shows the maximum safe power dissipation in the package vs. the ambient temperature for the packages available

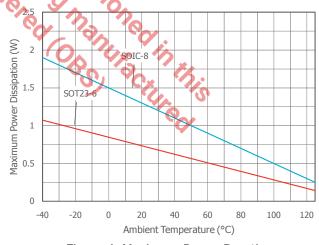


Figure 4. Maximum Power Derating

Driving Capacitive Loads

Increased phase delay at the output due to capacitive loading can cause ringing, peaking in the frequency response, and possible unstable behavior. Use a series resistance, Rs, between the amplifier and the load to help improve stability and settling performance. Refer to Figure 5.

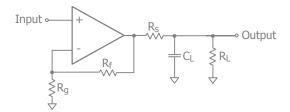


Figure 5. Addition of R_S for Driving Capacitive Loads

Table 1 provides the recommended R_S for various capacitive loads. The recommended R_S values result in <=1dB peaking in the frequency response. The Frequency Response vs. C_L plots, on page 7, illustrates the response of the CLC1002.

C _L (pF)	R _S (Ω)	-3dB BW (MHz)
10	43	\$275
22	30	235
47	20	190
100	12	146
470	4.3	72

Table 1: Recommended R_S vs. C_I

For a given load capacitance, adjust $R_{\rm S}$ to optimize the tradeoff between settling time and bandwidth. In general reducing $R_{\rm S}$ will increase bandwidth at the expense of additional overshoot and ringing.

Overdrive Recovery

An overdrive condition is defined as the point when either one of the inputs or the output exceed their specified voltage range. Overdrive recovery is the time needed for the amplifier to return to its normal or linear operating point. The recovery time varies, based on whether the input or output is overdriven and by how much the range is exceeded. The CLC1002 will typically recover in less than 25ns from an overdrive condition. Figure 6 shows the CLC1002 in an overdriven condition.

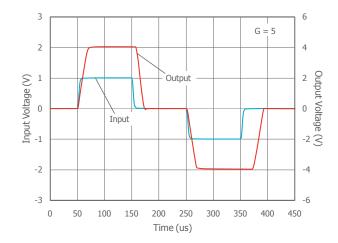


Figure 6. Overdrive Recovery

Layout Considerations

General layout and supply bypassing play major roles in high frequency performance. Exar has evaluation boards to use as a guide for high frequency layout and as aid in device testing and characterization. Follow the steps below as a basis for high frequency layout:

- Include 6.8µF and 0.1µF ceramic capacitors for power supply decoupling
- Place the 6.8µF capacitor within 0.75 inches of the power pin
- Place the 0.1µF capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- Minimize all trace lengths to reduce series inductances
 Refer to the evaluation board layouts below for more information.

Evaluation Board Information

The following evaluation boards are available to aid in the testing and layout of these devices:

Evaluation Board	Products
CEB002	CLC1002 in SOT23-5
CEB003	CLC1002 in SOIC-8

Evaluation Board Schematics

Evaluation board schematics and layouts are shown in Figures 7-11. These evaluation boards are built for dual- supply operation. Follow these steps to use the board in a single-supply application:

- 1. Short -Vs to ground.
- 2. Use C3 and C4, if the ${ ext{-V}_{\text{S}}}$ pin of the amplifier is not directly connected to the ground plane.

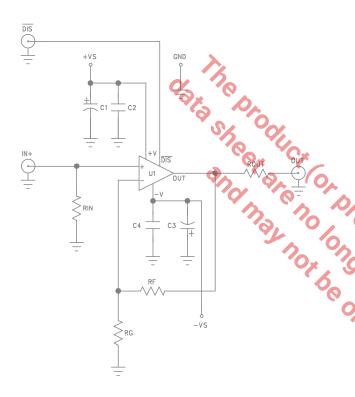


Figure 7. CEB002/CEB003 Schematic

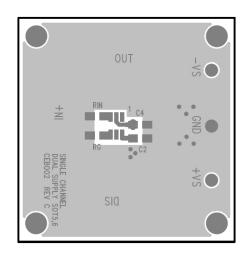


Figure 8. CEB002 Top View

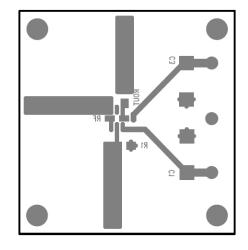


Figure 9. CEB002 Bottom View

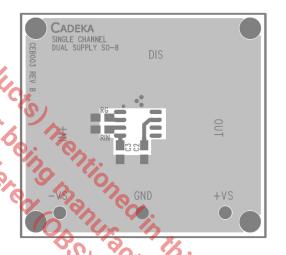


Figure 10. CEB003 Top View

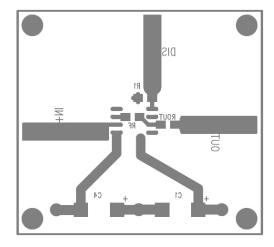
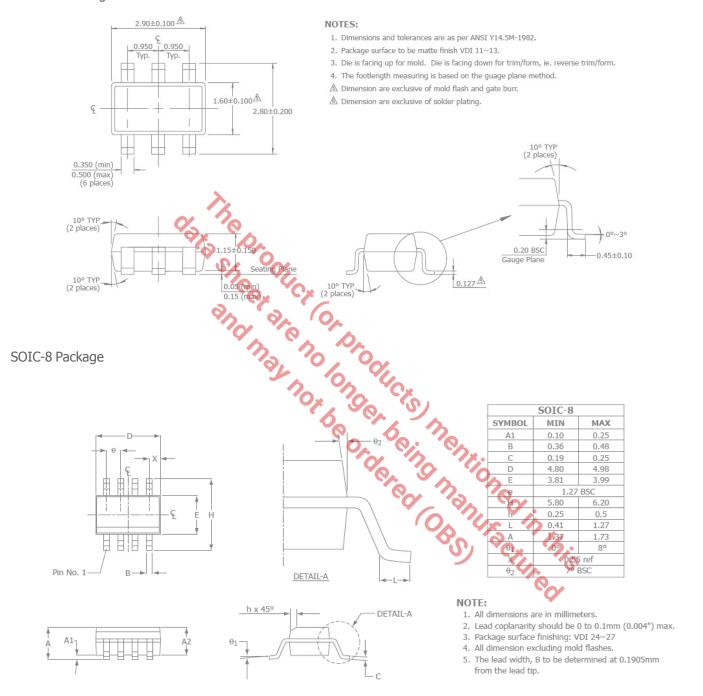


Figure 11. CEB003 Bottom View

Mechanical Dimensions

SOT23-6 Package



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